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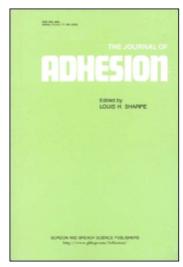
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Note from the Editor

We are pleased to report that we have made a reciprocal agreement with another China Journal, "Technology on Adhesion & Sealing", through its Editor Mr. Wu Yaru, similar to the one which we recently made with the China Journal Chemistry and Adhesion.

The Journal of Adhesion will publish the Contents Lists and Abstracts from Technology on Adhesion & Sealing, a new Journal, on a regular basis as their issues appear. In return, that Journal will publish Contents Lists and Abstracts appearing in The Journal of Adhesion, on a regular basis.

As we have said before, we believe that this will further broaden our interest to our readers and increase their awareness of what is going on in the field of adhesion in China. In addition, our authors' work will be made known to a large new readership of adhesion scientists and technologists in China.

We would like to thank Professor Hiroshi Mizumachi of the University of Tokyo for his help in making this arrangement possible.

The Contents Lists and Abstracts of the first two issues of this new Journal follow.